# International IOR Rectifier

### **AUTOMOTIVE GRADE**

PD - 97765A

## AUIRFI4905

#### **Features**

- Advanced Planar Technology
- P-Channel MOSFET
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified \*

### **Description**

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.





V <sub>(BR)DSS</sub>	-55V
R <sub>DS(on)</sub> max.	$0.02\Omega$
I <sub>D</sub>	-74A



G	D	S
Gate	Drain	Source

### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T<sub>A</sub>) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	-74	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	-52	Α
I <sub>DM</sub>	Pulsed Drain Current ①	-260	
P <sub>D</sub> @T <sub>C</sub> = 25°C	Power Dissipation	200	W
	Linear Derating Factor	1.3	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited) <sup>②</sup>	930	mJ
I <sub>AR</sub>	AR Avalanche Current ①		Α
E <sub>AR</sub>	Repetitive Avalanche Energy ③	20	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-5.0	V/ns
$T_J$	Operating Junction and	-55 to + 175	
T <sub>STG</sub>	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		0.75	°C/W
$R_{\theta JA}$	Junction-to-Ambient		65	

HEXFET® is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	-55			٧	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		-0.05		V/°C	Reference to 25°C, I <sub>D</sub> = -1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			0.02	Ω	V <sub>GS</sub> = -10V, I <sub>D</sub> = -38A ④
$V_{GS(th)}$	Gate Threshold Voltage	-2.0		-4.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
gfs	Forward Transconductance	21			S	$V_{DS} = -25V, I_{D} = -38A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current		_	-25	μΑ	$V_{DS} = -55V, V_{GS} = 0V$
				-250	İ	$V_{DS} = -44V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100		V <sub>GS</sub> = -20V

### Dynamic Electrical Characteristics @ T<sub>1</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Qg	Total Gate Charge			180		$I_D = -38A$
Q <sub>gs</sub>	Gate-to-Source Charge			32	nC	$V_{DS} = -44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge			86		V <sub>GS</sub> = -10V ④
t <sub>d(on)</sub>	Turn-On Delay Time		18			$V_{DD} = -50V$
t <sub>r</sub>	Rise Time		99			$I_D = -33A$
t <sub>d(off)</sub>	Turn-Off Delay Time		61		ns	$R_G = 6.8 \Omega$
t <sub>f</sub>	Fall Time		96			V <sub>GS</sub> = -10V ④
L <sub>D</sub>	Internal Drain Inductance		4.5			Between lead,
					nH	6mm (0.25in.)
L <sub>S</sub>	Internal Source Inductance		7.5		1	from package
						and center of die contact
C <sub>iss</sub>	Input Capacitance		3400			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		1400		pF	$V_{DS} = -25V$
$C_{rss}$	Reverse Transfer Capacitance		640			f = 1.0MHz

### **Diode Characteristics**

	Parameter	Min.	Тур.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current			-74		MOSFET symbol
	(Body Diode)				Α	showing the
I <sub>SM</sub>	Pulsed Source Current			-260		integral reverse
	(Body Diode) ①					p-n junction diode.
$V_{SD}$	Diode Forward Voltage			-1.6	V	$T_J = 25^{\circ}C, I_S = -38A, V_{GS} = 0V \oplus$
t <sub>rr</sub>	Reverse Recovery Time		89	130	ns	$T_J = 25^{\circ}C, I_F = -38A$
Q <sub>rr</sub>	Reverse Recovery Charge		230	350	nC	di/dt = 100A/μs ④
t <sub>on</sub>	Forward Turn-On Time	Intrinsi	c turn-or	time is	negligib	le (turn-on is dominated by LS+LD)

#### Notes

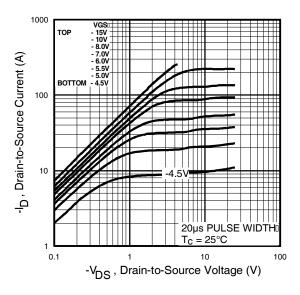
- $\ensuremath{\mathbb{O}}$  Repetitive rating; pulse width limited by  $\ensuremath{\text{ max.}}$  junction temperature. ( See fig. 11 )
- ② Starting  $T_J = 25$ °C, L = 1.3mH,  $R_G = 25\Omega$ ,  $I_{AS} = -38A$ . (See Figure 12)
- $\label{eq:local_local_local_local} \mbox{\Large $0$} \mbox{ I}_{SD} \leq \mbox{-38A, di/dt} \leq \mbox{-270A/$\mu s}, \ \mbox{$V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 175^{\circ}$C} \,.$
- 4 Pulse width  $\leq$  300 $\mu$ s; duty cycle  $\leq$  2%.
- $\ ^{\textcircled{5}}$  R  $_{\theta}$  is measured at TJ approximately 90°C.

### Qualification Information<sup>†</sup>

		Automotive				
		(per AEC-Q101)				
Qualification	Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		TO-220 Fullpak	N/A			
	Machine Model		Class M4 (+/- 700V) <sup>††</sup>			
		AEC-Q101-002				
F0D	Human Body Model		Class H2 (+/- 4000V) <sup>††</sup>			
ESD			AEC-Q101-001			
	Charged Device Model	Class C5 (+/- 2000V) <sup>††</sup>				
		AEC-Q101-005				
RoHS Compliant Yes			Yes			

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

<sup>††</sup> Highest passing voltage.



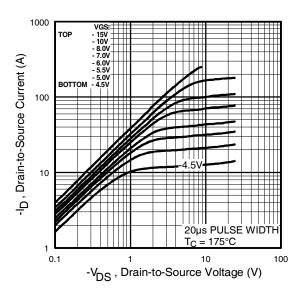
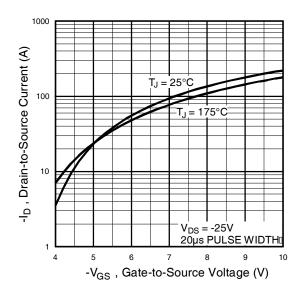


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



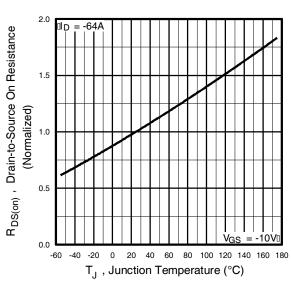
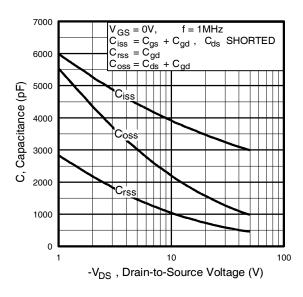


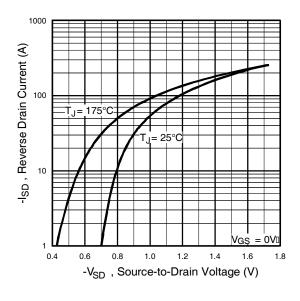
Fig 3. Typical Transfer Characteristics

**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



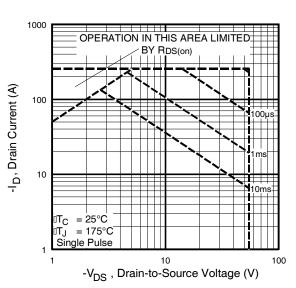


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

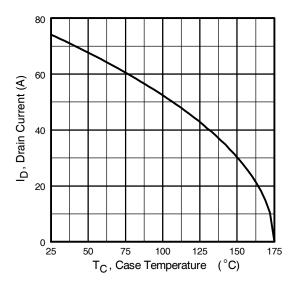


Fig 9. Maximum Drain Current Vs.

Case Temperature

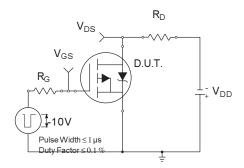


Fig 10a. Switching Time Test Circuit

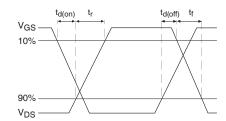
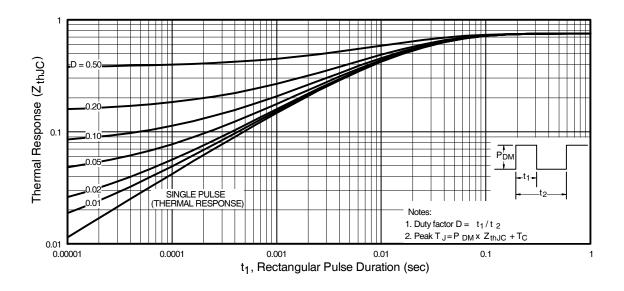


Fig 10b. Switching Time Waveforms



 $\textbf{Fig 11.}\ Maximum\ Effective\ Transient\ Thermal\ Impedance,\ Junction-to-Case$ 

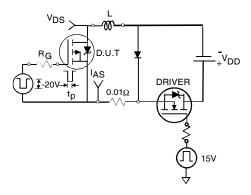


Fig 12a. Unclamped Inductive Test Circuit

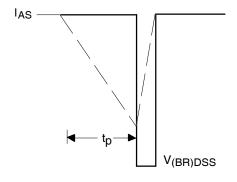


Fig 12b. Unclamped Inductive Waveforms

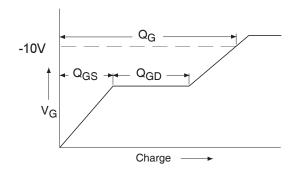


Fig 13a. Basic Gate Charge Waveform

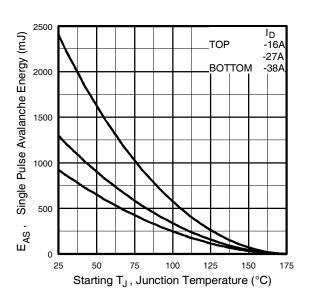


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

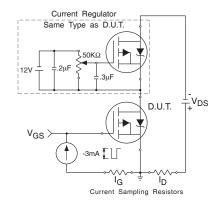
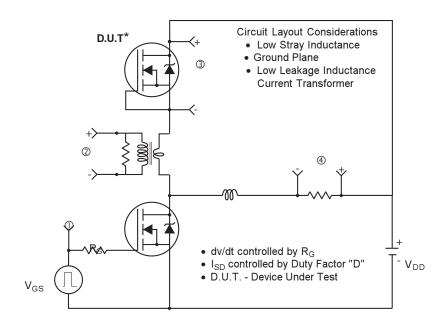
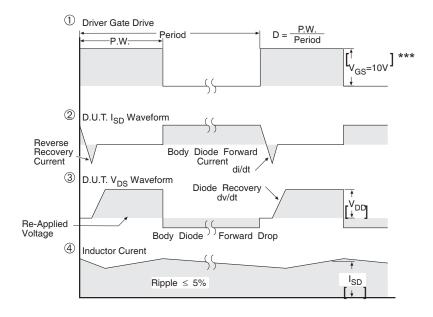


Fig 13b. Gate Charge Test Circuit

### Peak Diode Recovery dv/dt Test Circuit



<sup>\*</sup> Reverse Polarity of D.U.T for P-Channel



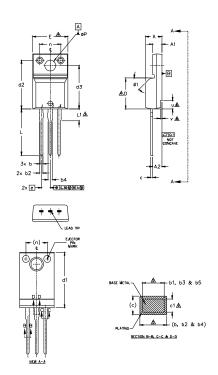
\*\*\*  $V_{GS}$  = 5.0V for Logic Level and 3V Drive Devices

Fig 14. For P-Channel HEXFETS

## AUIRFI4905

## TO-220AB Full-Pak Package Outline

Dimensions are shown in millimeters (inches)



S Y M	DIMENSIONS					
BO	MILLIMETERS INCHES				O T	
L	MIN.	MAX.	MIN.	MAX.	Ė S	
Α	4.57	4.83	.180	.190		
A1	2.57	2.83	.101	,111		
A2	2.51	2.93	.099	.115		
b	0.61	0.94	.024	.037		
b1	0.61	0.89	.024	.035	5	
b2	0.76	1.27	.030	.050		
b3	0.76	1.22	.030	.048	5	
b4	1.02	1.52	.040	.060		
b5	1.02	1.47	.040	.058	5	
С	0.33	0.63	.013	.025		
c1	0.33	0.58	.013	.023	5	
D	8.66	9.80	.341	.386	4	
d1	15,80	16,13	.622	.635		
d2	13,97	14.22	.550	.560		
d3	12.30	12.93	.484	.509		
E	9.63	10.75	.379	.423	4	
e		BSC		BSC		
L	13.20	13.72	.520	.540		
L1	3.37	3,67	.122	.145	3	
n	6.05	6.60	.238	.260		
øΡ	3,05	3,45	.120	.136		
u	2.40	2.50	.094	.098	6	
V	0.40	0.50	.016	.020	6	
ø1	-	45*	-	45"		

- NOTES:

  O DIMENSIONING AND TOLERANCING AS FER ASME Y14.5 M = 1994.

  DIMENSIONS ARE SHOWN IN MULIMETERS [INCHES]

  AND DIMENSIONS ARE PROBLEM IN MULIMETERS [INCHES]

  DIMENSION IN B. E DO NOT NULIDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED DON'S (0.127) PERS SIZE. THESE DIMENSIONS ARE MEASURED AT THE OUTER WOST EXTREMES OF THE PLASTIC BODY.

  DIMENSION IS, D.S. BO & CLAPPLY TO BASE WETAL ONLY.

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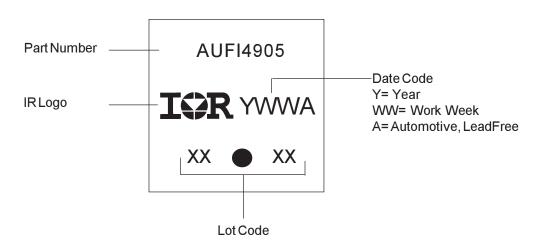
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#### LEAD ASSIGNMENTS

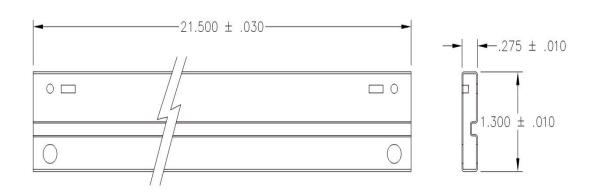
## IGBTs. CoPACK 1.- GATE 2.- COLLECTOR

## TO-220AB Full-Pak Part Marking Information



Note: For the most current drawing please refer to IR website at <a href="http://www.irf.com/package/">http://www.irf.com/package/</a>

## TO-220AB Full-Pak Tube Sketch



International

TOR Rectifier

## AUIRFI4905

## **Ordering Information**

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFI4905	TO-220 Fullpak	Tube	50	AUIRFI4905

# International TOR Rectifier

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